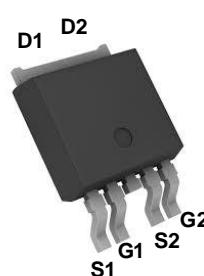
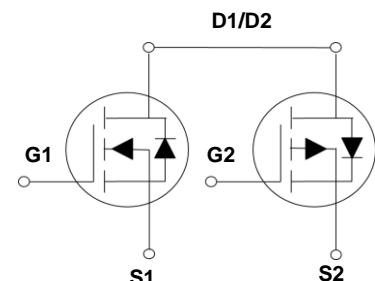


Main Product Characteristics

BV _{DSS}	60V	-60V
R _{DS(ON)}	30mΩ	48mΩ
I _D	19A	-17A



TO-252-4L



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFD06C20 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	N-Ch	P-Ch	Unit
Drain-Source Voltage	V _{DS}	60	-60	V
Gate-Source Voltage	V _{GS}	±20	±20	V
Drain Current-Continuous($T_C=25^\circ\text{C}$)	I _D	19	-17	A
Drain Current-Continuous($T_C=100^\circ\text{C}$)		12	-10.7	A
Drain Current-Pulsed ¹	I _{DM}	76	68	A
Single Pulse Avalanche Energy ²	E _{AS}	26.4	54.4	mJ
Single Pulse Avalanche Current ²	I _{AS}	23	33	A
Power Dissipation($T_C=25^\circ\text{C}$)	P _D	20.1		W
Power Dissipation-Derate Above 25°C		0.16		W/°C
Thermal Resistance, Junction-to-Case	R _{θJC}	6.2		°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62		°C/W
Storage Temperature Range	T _{STG}	-55 To +150		°C
Operating Junction Temperature Range	T _J	-55 To +150		°C

N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	-	-	V
BV_{DSS} Temperature Coefficient	$\triangle \text{BV}_{\text{DSS}}/\triangle T_J$	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	-	0.07	-	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	1	μA
		$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On Characteristics						
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=15\text{A}$	-	25	30	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=10\text{A}$	-	28	36	
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}$	1.2	1.6	2.5	V
$V_{\text{GS}(\text{th})}$ Temperature Coefficient	$\triangle V_{\text{GS}(\text{th})}$	$I_{\text{D}}=250\mu\text{A}$	-	-4.6	-	$\text{mV}/^\circ\text{C}$
Forward Transconductance	g_{FS}	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=3\text{A}$	-	10	-	S
Dynamic and Switching Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	1180	1720	pF
Output Capacitance	C_{oss}		-	68	100	
Reverse Transfer Capacitance	C_{rss}		-	45	70	
Turn-On Delay Time ^{3,4}	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=30\text{V}, R_{\text{G}}=6\Omega$ $V_{\text{GS}}=10\text{V}, I_{\text{D}}=1\text{A}$	-	4.6	9	nS
Rise Time ^{3,4}	t_{r}		-	14.8	28	
Turn-Off Delay Time ^{3,4}	$t_{\text{d}(\text{off})}$		-	27.2	52	
Fall Time ^{3,4}	t_{f}		-	7.8	15	
Total Gate Charge ^{3,4}	Q_{g}	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=10\text{A}, V_{\text{GS}}=10\text{V}$	-	16.6	24	nC
Gate-Source Charge ^{3,4}	Q_{gs}		-	2.2	4.4	
Gate-Drain Charge ^{3,4}	Q_{gd}		-	3.9	8	
Gate Resistance	R_{g}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$	-	2.1	4.2	Ω
Drain-Source Diode Characteristics						
Continuous Source Current	I_{s}	Force Current	-	-	19	A
Pulsed Source Current	I_{SM}		-	-	38	A
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=1\text{A}, T_J=25^\circ\text{C}$	-	-	1	V

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{\text{DD}}=25\text{V}, V_{\text{GS}}=10\text{V}, L=0.1\text{mH}$, N-CH $I_{\text{AS}}=23\text{A}$, P-CH $I_{\text{AS}}=33\text{A}$, $R_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$.
- The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

P-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-60	-	-	V
BV_{DSS} Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to 25°C , $I_{\text{D}}=-1\text{mA}$	-	-0.05	-	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=-60\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	-1	μA
		$V_{\text{DS}}=-48\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	-10	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On Characteristics						
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-15\text{A}$	-	40	48	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-10\text{A}$	-	53	68	
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1.2	-1.6	-2.5	V
$V_{\text{GS(th)}}$ Temperature Coefficient	$\Delta V_{\text{GS(th)}}$		-	5	-	$\text{mV}/^\circ\text{C}$
Forward Transconductance	g_{FS}	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-3\text{A}$	-	10	-	S
Dynamic and Switching Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$	-	1250	1810	pF
Output Capacitance	C_{oss}		-	85	125	
Reverse Transfer Capacitance	C_{rss}		-	65	95	
Turn-On Delay Time ^{2,3}	$t_{\text{d(on)}}$	$V_{\text{DD}}=-30\text{V}, R_{\text{G}}=6\Omega, V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-1\text{A}$	-	13	25	nS
Rise Time ^{2,3}	t_{r}		-	42.4	81	
Turn-Off Delay Time ^{2,3}	$t_{\text{d(off)}}$		-	64.6	123	
Fall Time ^{2,3}	t_{f}		-	16.4	31	
Total Gate Charge ^{2,3}	Q_{g}	$V_{\text{DS}}=-30\text{V}, I_{\text{D}}=-8\text{A}, V_{\text{GS}}=-10\text{V}$	-	22.4	31	nC
Gate-Source Charge ^{2,3}	Q_{gs}		-	4.1	6	
Gate-Drain Charge ^{2,3}	Q_{gd}		-	5.2	7	
Gate Resistance	R_{g}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$	-	15	30	Ω
Drain-Source Diode Characteristics						
Continuous Source Current	I_{s}	Force Current	-	-	-17	A
Pulsed Source Current	I_{SM}		-	-	-34	A
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=-1\text{A}, T_J=25^\circ\text{C}$	-	-	-1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

N-Channel Typical Electrical and Thermal Characteristic Curves

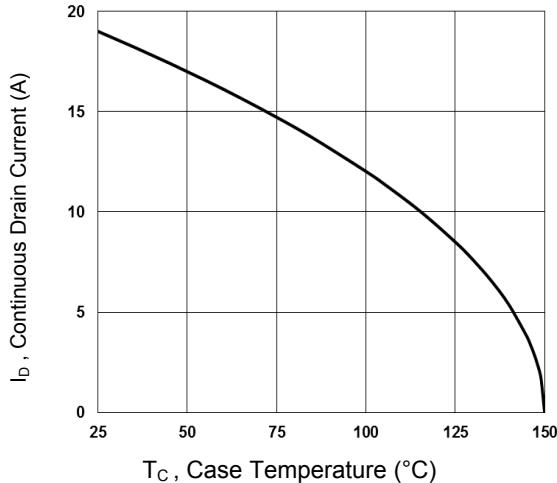


Figure 1. Continuous Drain Current vs. T_C

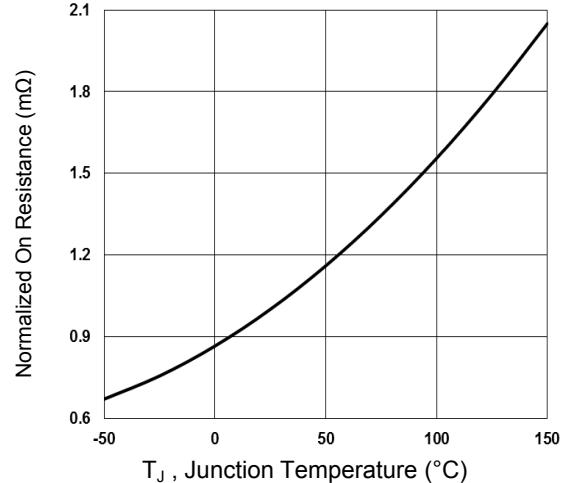


Figure 2. Normalized R_{DSON} vs. T_J

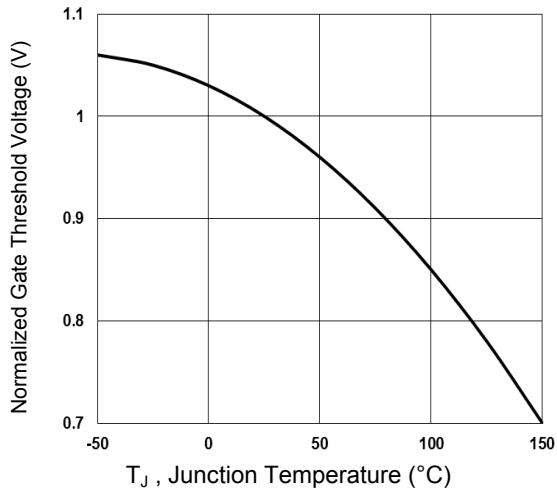


Figure 3. Normalized V_{th} vs. T_J

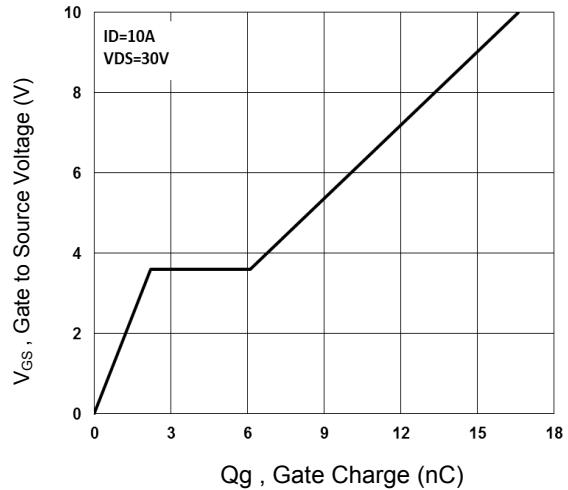


Figure 4. Gate Charge Waveform

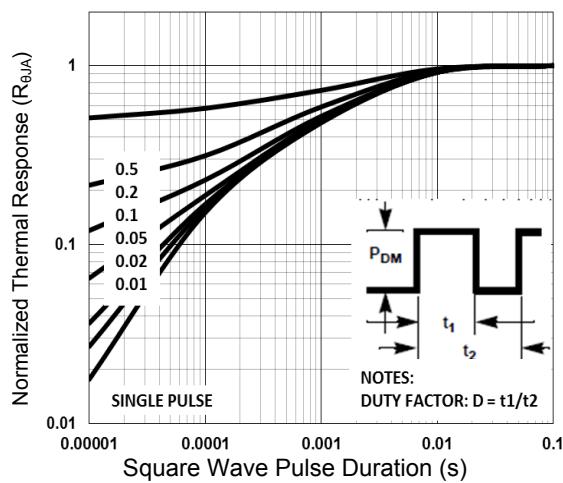


Figure 5. Normalized Transient Impedance

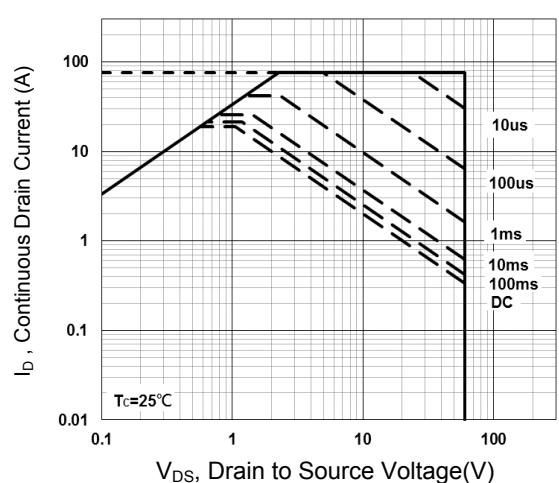


Figure 6. Maximum Safe Operation Area

P-Channel Typical Electrical and Thermal Characteristic Curves

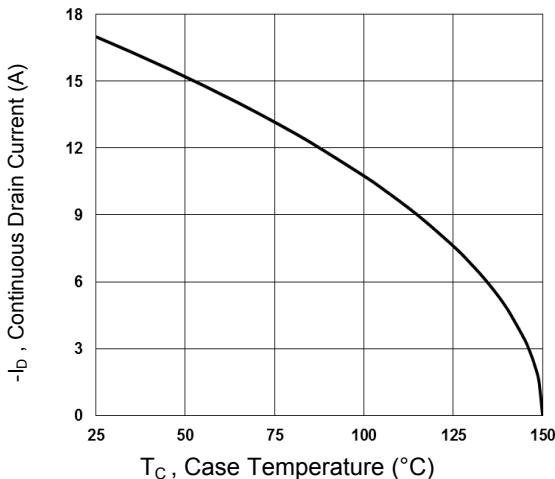


Figure 7. Continuous Drain Current vs. T_c

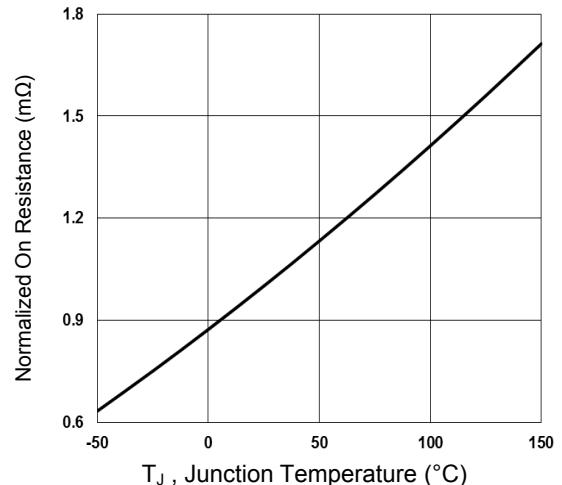


Figure 8. Normalized R_{DSON} vs. T_j

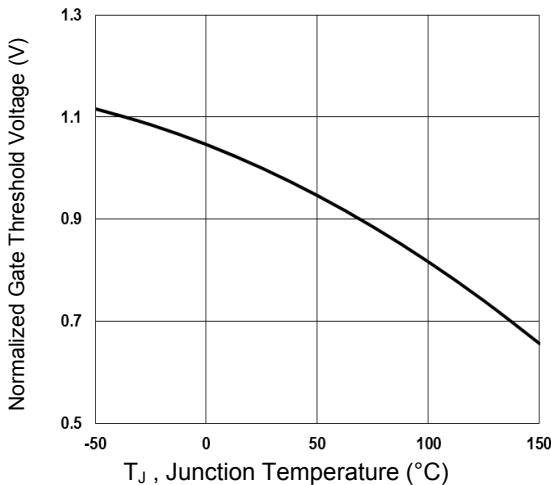


Figure 9. Normalized V_{th} vs. T_j

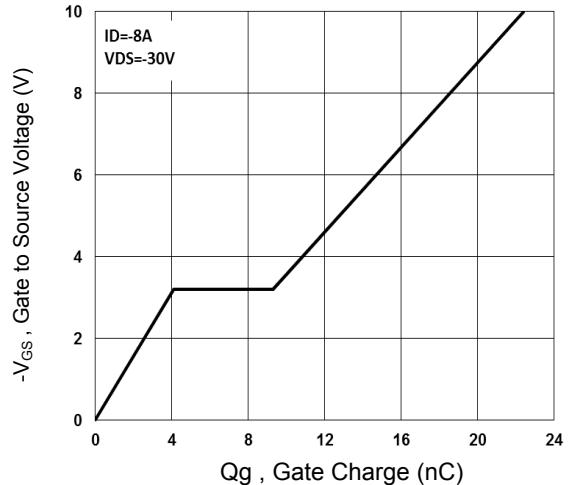


Figure 10. Gate Charge Waveform

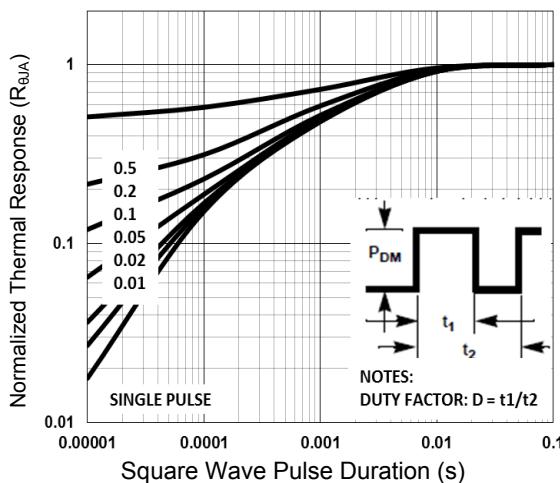


Figure 11. Normalized Transient Impedance

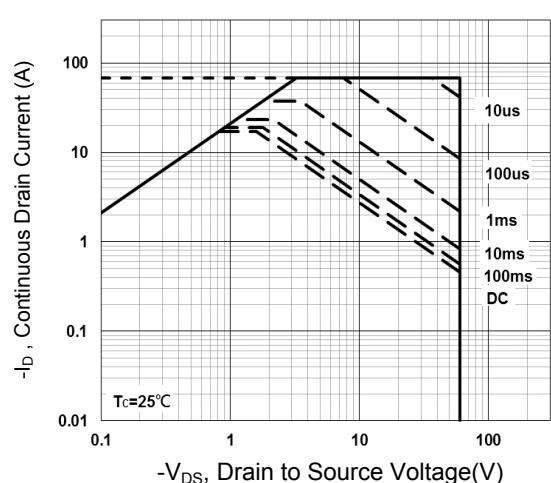
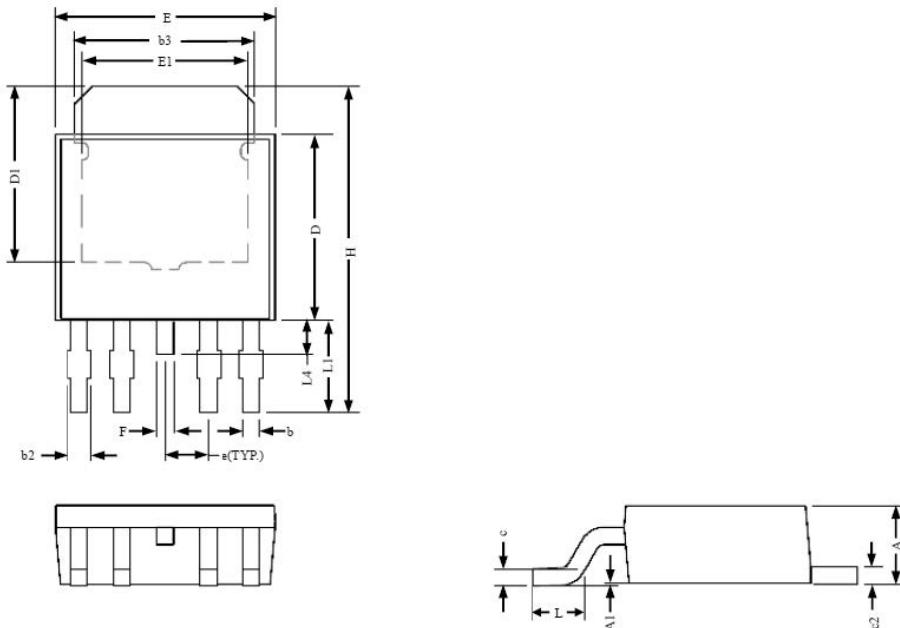


Figure 12. Maximum Safe Operation Area

Package Outline Dimensions (TO-252-4L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.400	2.200	0.094	0.087
A1	0.150	0.000	0.006	0.000
B	0.600	0.400	0.024	0.016
b2	0.800	0.500	0.031	0.020
b3	5.500	5.200	0.217	0.205
C	0.508typ.		0.02typ.	
c2	0.550	0.450	0.022	0.018
D	5.800	5.400	0.228	0.213
D1	---	4.570	---	0.180
E	6.800	6.400	0.268	0.252
E1	---	3.810	---	0.150
E	1.27ref.		0.05ref.	
F	0.600	0.400	0.024	0.016
H	10.200	9.400	0.402	0.370
L	1.770	1.400	0.070	0.055
L1	3.000	2.400	0.118	0.094
L4	1.200	0.800	0.047	0.031